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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/789,044	02/27/2004	Kie Y. Ahn	1303.070US2	8340
21186	7590 05/16/2005		EXAMINER	
SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.			MENZ, DOUGLAS M	
P.O. BOX 2938 MINNEAPOLIS, MN 55402-0938			ART UNIT	PAPER NUMBER
			2891	
			DATE MAILED: 05/16/200	5

Please find below and/or attached an Office communication concerning this application or proceeding.

•	Application No.	Applicant(s)				
	10/789,044	AHN ET AL.				
Office Action Summary	Examiner	Art Unit				
	Douglas M. Menz	2891				
The MAILING DATE of this communicate Period for Reply	ation appears on the cover sheet v	vith the correspondence addre	ss			
A SHORTENED STATUTORY PERIOD FOR THE MAILING DATE OF THIS COMMUNIC. - Extensions of time may be available under the provisions of after SIX (6) MONTHS from the mailing date of this commun. - If the period for reply specified above is less than thirty (30) of the two period for reply is specified above, the maximum statut. - Failure to reply within the set or extended period for reply will Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	ATION. 37 CFR 1.136(a). In no event, however, may a ication. 14 icays, a reply within the statutory minimum of the tory period will apply and will expire SIX (6) MO I, by statute, cause the application to become A	reply be timely filed irty (30) days will be considered timely. NTHS from the mailing date of this commu	unication.			
Status						
1) Responsive to communication(s) filed	on <u>18 <i>April 2005</i></u> .					
2a) This action is FINAL . 2b)⊠ This action is non-final.					
3)☐ Since this application is in condition fo	☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice	under Ex parte Quayle, 1935 C.	D. 11, 453 O.G. 213.				
Disposition of Claims		•				
4) ☐ Claim(s) 1-40 is/are pending in the appear 4a) Of the above claim(s) 5-40 is/are w 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-4 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction	rithdrawn from consideration.					
Application Papers			·			
9) The specification is objected to by the 10. The drawing(s) filed on 2 27 s/s/are: a Applicant may not request that any objection Replacement drawing sheet(s) including the 11) The oath or declaration is objected to be	n) accepted or b) objected to on to the drawing(s) be held in abeya se correction is required if the drawing	ince. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR 1				
Priority under 35 U.S.C. § 119	•					
12) Acknowledgment is made of a claim for a) All b) Some * c) None of: 1. Certified copies of the priority do 2. Certified copies of the priority do 3. Copies of the certified copies of application from the International	ocuments have been received. In the priority documents have been the priority documents have been the priority documents have been the large of the	Application No received in this National Sta	ge			
Attachment(c)	•					
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO 3) Information Disclosure Statement(s) (PTO-1449 or PT Paper No(s)/Mail Date 4/18/05, 2/27/04.	-948) Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application (PTO-152 arch History.	2)			

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of Species I, claims 1-4, in the reply filed on 4/18/05 is acknowledged.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1-3 are rejected under 35 U.S.C. 103(a) as being unpatentable over VanDover (US 6093944) in view of Scobey et al. (US 6115401).

Regarding claim 1, VanDover discloses an electronic device comprising:

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A substrate (Col. 4, line 24 – Col. 5, line 19); and

A dielectric layer disposed on the substrate (Col. 4, line 24 - Col. 5, line 19), the dielectric layer containing a TiO₂ layer doped with a lanthanide (Col. 3, lines: 39-53 and Col. 5, lines: 21-48).

VanDover further discloses that the TiO₂ layer is formed by a reactive sputtering method and that other methods may be used, such as ion beam sputtering (Col. 8, lines: 30-39). However, VanDover does not explicitly disclose wherein the TiO₂ layer is formed by ion assisted electron beam evaporation.

Scobey discloses that dielectric layers of metal oxide materials can be produced by commercially known plasma deposition techniques, such as ion assisted electron beam evaporation and ion beam sputtering and further that both methods produce advantageously dense and stable materials (Col. 10, lines: 50-67).

Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to form VanDover's TiO₂ layer by ion assisted electron beam evaporation, as taught by Scobey (Col. 10, lines: 50-67) instead of by ion beam sputtering, since Scobey explicitly teaches that ion assisted electron beam evaporation can be used in place of ion beam sputtering to produce metal oxide layers that are advantageously dense and stable (Col. 10, lines: 50-65).

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Regarding claim 2, VanDover further discloses wherein the lanthanide has a concentration in the dielectric layer of between about 10% and about 30% of the dielectric layer (Col. 3, lines: 39-50).

Regarding claim 3, VanDover further discloses wherein the dielectric layer has a dielectric constant of greater than 45 (Col. 8, lines: 60-61), which would include applicant's claimed dielectric constant range of about 50 to about 110.

Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over VanDover (US 6093944) in view of Scobey et al. (US 6115401) as applied to claim 1 above, and further in view of Gardner et al. (US 6225168).

Regarding claim 4, VanDover in view of Scobey disclose the limitations of claim 1 as mentioned above, however they do not explicitly disclose that the dielectric layer has an equivalent oxide thickness (t_{eq}) in the range from about 1.5 Angstroms to about 5 Angstroms.

Applicant specifically defines the term "t_{eq}" on page 6, lines: 9-12 of the specification, which is further expressed by the mathematical relationship given on page 7 of the specification.

Using Applicant's definition and mathematical relationship, the Examiner has concluded that a t_{eq} in the range from about 1.5 Angstroms to about 5 Angstroms would correspond to TiO₂ dielectric layer having a physical thickness range of about 17

Angstroms to about 57 Angstroms with a dielectric constant of 45, however, VanDover's dielectric constant can be greater than 45 (Col. 8, lines: 60-61). For example, if VanDover's dielectric constant is 100, then the physical thickness range would be about 38 Angstroms to about 128 Angstroms.

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Therefore, in order to satisfy the limitation of claim 4, the Examiner must show a physical thickness of the TiO₂ layer to be greater than 17 Angstroms.

VanDover's specific application example is directed to a capacitor, which requires the thickness of the dielectric to be a function of the capacitance. However, VanDover expressly discloses that the dielectric can be used for MOSFET gate dielectrics (Col. 4, line 30).

Gardner discloses a MOS transistor with a TiO₂ gate dielectric, wherein a suitable thickness for the TiO₂ gate dielectric layer ranges from about 15 Angstroms to about 400 Angstroms (Gardner Col. 3, lines: 20-25).

It would have been obvious to one of ordinary skill in the art at the time of the invention to incorporate VanDover's dielectric material into a MOSFET gate dielectric with Gardner's dielectric thickness range since both dielectrics are composed of TiO₂ and since VanDover expressly discloses that the dielectric can be used for MOSFET gate dielectrics (Col. 4, line 30).

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. US patent 5646583 discloses the use of ion assisted electron beam evaporation used specifically to maintain a smooth surface (Col. 4).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Douglas M. Menz whose telephone number is 571-272-1877. The examiner can normally be reached on M-F 8-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bill Baumeister can be reached on 571-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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